

Electronic Patent Application Fee Transmittal

Application Number:	10534962			
Filing Date:	16-May-2005			
Title of Invention:	CIRCUIT BOARD, MULTI-LAYER WIRING BOARDS, METHOD OF PRODUCING CIRCUIT BOARDS AND METHOD OF PRODUCING MULTILAYER WIRING BOARDS			
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Patent-Appeals-and-Interference:				
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Utility Appl issue fee	1501	1	1510	1510
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